Department of Defense Fiscal Year (FY) 2017 President's Budget Submission

February 2016



Office of the Secretary Of Defense

Defense-Wide Justification Book Volume 1 of 1

Defense Production Act Purchases

THIS PAGE INTENTIONALLY LEFT BLANK

Office of the Secretary Of Defense • President's Budget Submission FY 2017 • Procurement

Table of Volumes

Chemical and Biological Defense ProgramVo	olume 1
Defense Contract Audit Agency	
Defense Contract Management Agency Vo	olume 1
DoD Human Resources Activity	olume 1
Defense Information Systems AgencyVo	olume 1
Defense Logistics AgencyVo	olume 1
Defense Media Activity Vo	
Defense Production Act Purchases	olume 1
Defense Security Cooperation AgencyVo	olume 1
Defense Security Service	
Defense Threat Reduction AgencyVo	olume 1
Department of Defense Education Activity	olume 1
Office of the Secretary Of Defense	olume 1
The Joint Staff	olume 1
United States Special Operations Command	
Washington Headquarters ServiceVo	olume 1

Office of the Secretary Of Defense • President's Budget Submission FY 2017 • Procurement

Joint Urgent Operational Needs FundVolum	e 1
Missile Defense Agency Volum	e 2

Office of the Secretary Of Defense • President's Budget Submission FY 2017 • Procurement

Volume 1 Table of Contents

Comptroller Exhibit P-1	Volume 1 - v
Line Item Table of Contents (by Appropriation then Line Number)	Volume 1 - vii
Line Item Table of Contents (Alphabetically by Line Item Title)	Volume 1 - ix
Exhibit P-40s	Volume 1 - 1

THIS PAGE INTENTIONALLY LEFT BLANK

Defense-Wide FY 2017 President's Budget Exhibit P-1 FY 2017 President's Budget Total Obligational Authority (Dollars in Thousands)

11 Jan 2016

Appropriation: 0360D Defense Production Act Purchases

		FY 20	015	FY 2	016	FY 20	16	FY 2	016	S
Line	Ident	(Base a	& OCO)	Base E	nacted	OCO Ena	cted	Total E	nacted	e
No Item Nomenclature	Code	Quantity	Cost	Quantity	Cost	Quantity	Cost	Quantity	Cost	С
										-
Budget Activity 01: Defense Production Act Purchases										
Defense Production Act Purchases										
1 Defense Production Act Purchases	A		96,638		76,680				76,680	0.0840
Total Defense Production Act Purchases			96,638		76,680				76,680	
Total Defense Production Act Purchases			96,638		76,680			0.00	76,680	

P-1C1: FY 2017 President's Budget (Published Version of PB Position), as of January 11, 2016 at 10:38:45

Defense-Wide FY 2017 President's Budget Exhibit P-1 FY 2017 President's Budget Total Obligational Authority (Dollars in Thousands)

11 Jan 2016

Appropriation: 0360D Defense Production Act Purchases

Line		Ident	FY 20 Bas		FY 20 OCO		FY 20 Tota		S e
No	Item Nomenclature	Code	Quantity	Cost	Quantity	Cost	Quantity	Cost	С
									100
	Activity 01: Defense Production Act Purchases								
Deren	be reduction Act ratenases								
1 De	fense Production Act Purchases	А		44,065				44,065	U
metel .	Defense Production Act Purchases								
Total .	Derense Production Act Purchases			44,065				44,065	
Total :	Defense Production Act Purchases			44,065				44,065	

P-1C1: FY 2017 President's Budget (Published Version of PB Position), as of January 11, 2016 at 10:38:45

Office of the Secretary Of Defense • President's Budget Submission FY 2017 • Procurement

Line Item Table of Contents (by Appropriation then Line Number)

Appropriation 0360D: Defense Production Act Purchases

Line #	BA	BSA	Line Item Number	Line Item Title	Page
1	01	10	TitleIII	Defense Production Act PurchasesVolume	1 - 1

THIS PAGE INTENTIONALLY LEFT BLANK

Office of the Secretary Of Defense • President's Budget Submission FY 2017 • Procurement

Line Item Table of Contents (Alphabetically by Line Item Title)

Line Item Title	Line Item Number	Line #	BA	BSA Page
Defense Production Act Purchases	TitleIII	1	01	10Volume 1 - 1

THIS PAGE INTENTIONALLY LEFT BLANK

xhibit P-40, Budget Line Item Justification: PB 2017 Office of the Secretary Of Defense Date: February 2016												
Appropriation / Budget Activity 0360D: Defense Production Act F Purchases / BSA 10: Defense Pro	Purchases / I	BA 01: Defe	ense Produc	ction Act		P-1 Line Item Number / Title: TitleIII / Defense Production Act Purchases						
ID Code (A=Service Ready, B=Not Service Ready):			Program Ele	ments for Co	de B Items: 0	902199D8Z		Other Relate	d Program El	ements: N/A		
Line Item MDAP/MAIS Code: N/A	Item MD	AP/MAIS Cod	le(s): N/A									
Resource Summary	Prior Years	FY 2015	FY 2016	FY 2017 Base	FY 2017 OCO	FY 2017 Total	FY 2018	FY 2019	FY 2020	FY 2021	To Complete	Total
Procurement Quantity (Units in Each)	-	-	-	-	-	-	-	-	-	-	-	-
Gross/Weapon System Cost (\$ in Millions)	1,598.637	96.638	76.680	44.065	-	44.065	37.109	38.657	35.939	30.348	Continuing	Continuing
Less PY Advance Procurement (\$ in Millions)	-	-	-	-	-	-	-	-	-	-	-	-
Net Procurement (P-1) (\$ in Millions)	1,598.637	96.638	76.680	44.065	-	44.065	37.109	38.657	35.939	30.348	Continuing	Continuing
Plus CY Advance Procurement (\$ in Millions)	-	-	-	-	-	-	-	-	-	-	-	-
Total Obligation Authority (\$ in Millions)	1,598.637	96.638	76.680	44.065	-	44.065	37.109	38.657	35.939	30.348	Continuing	Continuing
(The following	g Resource Sumr	mary rows are fo	or informational p	urposes only. Th	ne correspondin	g budget request:	s are documente	ed elsewhere.)				
Initial Spares (\$ in Millions)	-	-	-	-	-	-	-	-	-	-	-	-
Flyaway Unit Cost (\$ in Millions)	-	-	-	-	-	-	-	-	-	-	-	-
Gross/Weapon System Unit Cost (\$ in Millions)	-	-	-	-	-	-	-	-	-	-	-	-

Description:

Title III of the Defense Production Act (DPA) provides the Department of Defense (DoD) with a powerful tool to ensure the timely creation and availability of domestic production capabilities for technologies that have the potential for wide-ranging impact on the operational capabilities and technological superiority of U.S. defense systems. DPA Title III is unique in that it is the sole DoD program focused on creating, maintaining, protecting, expanding or restoring domestic production capacity to strengthen domestic industry and to establish the industrial base capacity for essential national defense capabilities.

The Defense Production Act is authorized by 50 U.S.C. App. 2061 et seq. This budget includes essential transformational initiatives using the authorities of Title III of the DPA. The multi-year projects in this budget will incentivize domestic sources to establish, strengthen, and expand domestic industrial base capabilities for key technologies that support transformational initiatives and maintain the technological superiority of U.S. defense systems.

In accordance with the provisions of the Defense Production Act of 1950, as amended, (50 U.S.C. App. 2061 et seq.), notification to Congress of the intent of the DoD to execute any of the projects described in this exhibit to correct domestic industrial base shortfalls for technologies and/or materials essential for the execution of the national security strategy of the United States will be provided via letter notification before the referenced projects are initiated.

Exhib	xhibit P-40, Budget Line Item Justification: PB 2017 Office of the Secretary Of Defense Date: February 2016										
Appropriation / Budget Activity / Budget Sub Activity: 0360D: Defense Production Act Purchases / BA 01: Defense Production Act Purchases / BSA 10: Defense Production Act Purchases						P-1 Line Item		-	S		
ID Cod	e (A=Service Ready, B=Not Service Ready):	lements for Code B	Items: 0902199D8Z	C	ther Related P	rogram E	lements: N/A				
Line Item MDAP/MAIS Code: N/A Item MDAP/MAIS Code(s): N/A											
	Exhibits Sch	hedule			Prior Years	FY 2015	FY 2016	FY 2017	/ Base	FY 2017 OCO	FY 2017 Total
Exhibit Type	Title*	Sube	exhibits	ID CD	Quantity / Total Cost (Each) / (\$ M)	Quantity / Total Cost (Each) I (\$ M)	Quantity / Total Cos (Each) I (\$ M)	st Quantity / T (Each) /		Quantity / Total Cost (Each) I (\$ M)	Quantity / Total Cost (Each) / (\$ M)
P-5	1 / Defense Production Act Purchases				- / 1,598.637	- / 96.638	- / 76.680	- /4	4.065	- / -	- / 44.065
P-40	Total Gross/Weapon System Cost				- / 1,598.637	- / 96.638	- / 76.680	- /4	4.065	- / -	- / 44.065
	Exhibits Sch	hedule			FY 2018	FY 2019	FY 2020	FY 2	021	To Complete	Total
Exhibit Type	Title*	Sube	exhibits	ID CD	Quantity / Total Cost (Each) / (\$ M)	Quantity / Total Cost (Each) I (\$ M)	Quantity / Total Cos (Each) I (\$ M)	st Quantity / T (Each) /		Quantity / Total Cost (Each) I (\$ M)	Quantity / Total Cost (Each) / (\$ M)
P-5	1 / Defense Production Act Purchases				- / 37.109	- / 38.657	- / 35.939	- / 30	0.348	Continuing	Continuing
P-40	Total Gross/Weapon System Cost			- / 37.109	- / 38.657	- / 35.939	- / 3	0.348	Continuing	Continuing	
*Title rep	presents 1) the Number / Title for Items; 2)) the Number / Title [DODIC] fo	or Ammur	nition;	and/or 3) the Number /	Title (Modification Type)	for Modifications.				
Note: To	tals in this Exhibit P-40 set may not be example.	act or sum exactly due to round	iding.								

Justification:

Strategic overview:

DPA Title III investments for DoD are informed by the Department's key investment strategy documents including the Quadrennial Defense Review (QDR) and the Long Range Research and Development Plan (LRRDP). Investments for DoD will enable the production of capacity for technologies and materials emerging from the technology base when the private sector is unable to respond within DoD timelines. Technology focus areas include space, undersea, air dominance, strike, missile defense, and emerging technologies.

The National Security Space Industrial and Supply Base (NSS ISB) Risk Mitigation Program was developed by the DoD to formulate a systematic process to fund mitigation efforts to rectify shortcomings in the space industrial and supply base. The objective is to ensure access to critical technologies and capabilities in the quality, quantity, and timeframes required to support U.S. Government space programs. Projects in this program are addressing cross-platform, multi-agency/Service requirements. FY 2017 and outyear funds will develop projects in response to risk mitigation determinations and prioritized critical requirements of stake holders in DoD and other agencies, as represented through the Department's Space Industrial Base Working Group.

Program Change Summary (\$ in Millions)

FY 2017 resources (\$M)

\$ 20.141 Previous President's Budget

+ 23.924 Realignment of resources for DoD priorities (listed below)

\$ 44.065 FY 2017 Current President's Budget request

FY 2017 Realignment of DoD resources \$23.924:

+ \$15.000 Support for the National Security Space Industrial and Supply Base - Space Industrial Base Capabilities

+ \$ 7.200 Support for a DoD advanced microelectronics Trusted Foundry

+ \$ 2.000 Navy's Next Generation Jammer gallium nitride (GaN) monolithic microwave integrated circuits (MMICs) and wideband circulator technologies for Next Generation Jammer (NGJ) program requirements

- \$.276 Efficiencies and Inflation Adjustments

FY 2016 resources (\$M):

Exhibit P-40, Budget Line Item Jus	tification: PB 2017 Office of the Secretary Of D	efense	Date: February 2016							
Appropriation / Budget Activity / Budget Sub Activity: P-1 Line Item Number / Title: 0360D: Defense Production Act Purchases / BA 01: Defense Production Act TitleIII / Defense Production Act Purchases Purchases / BSA 10: Defense Production Act Purchases TitleIII / Defense Production Act Purchases										
ID Code (A=Service Ready, B=Not Service Ready):	Program Elements for Code B Ite	ems: 0902199D8Z	Other Related Program Elements: N/A							
Line Item MDAP/MAIS Code: N/A	Item MDAP/MAIS Code(s): N/A									
 \$ 46.680 Previous President's Budget reques + 30.000 Congressional increase \$ 76.680 Total Appropriated 	t									
FY 2015 resources (\$M): \$ 21.638 FY 2015 request + 30.000 Congressional increase \$ 51.638 Total Appropriated + 45.000 Transfer from Department of Energy	y for Advanced Drop-In Biofuel Production									
\$ 96.638 Revised Total										
Activated Carbon Capacity Expansion (\$13.8)	\$30.000 FY 2015 Congressional increase was applied to the following projects, whose total values exceeded the amount of the Congressional increase: Activated Carbon Capacity Expansion (\$13.865) Thin Wall Castings for Military Applications (\$18.273)									
This budget includes essential transformation cost phasing of each of the projects is addres		ect descriptions are provided below for	or each of the P5 exhibit projects listed, and the single or multi-year							
FY 2017 Project Descriptions										
critical technologies and capabilities in the qu	NSS-ISB - Space Industrial Base Capabilities (FY 2017 and outyears): projects will fund mitigation efforts to rectify shortcomings in the space industrial and supply base. The objective is to ensure access to critical technologies and capabilities in the quality, quantity, and timeframes required to support U.S. Government space programs. Projects in this program are addressing cross-platform, multi-agency/Service requirements. Funds will develop projects in response to risk mitigation determinations and prioritized critical requirements of stake holders in DoD and other agencies, as represented through the Department's									
Projects Other (non NSS-ISB): Advanced Microelectronics Trusted Foundry (FY 2017 new start): This project supports the Department's efforts to maintain domestic trusted sources of advanced microelectronics production. AT&L's strategy is focused on improving capability to evaluate and validate trust of microelectronics parts and advance standards to incentivize the commercial marketplace to recognize trust as a competitive design standard, and develop alternative approaches to the current manufacturing-driven means of trust to enable broader DoD access to commercial state of the art technology.										
Next Generation Jammer GaN MMIC and Wideband Circulator (FY2017- FY2019 and Prior Years): This project is an investment in production technology and capacity expansion for gallium nitride (GaN) monolithic microwave integrated circuits (MMICs) and wideband circulator technologies for Next Generation Jammer (NGJ) program requirements. The objective is to establish/expand one or more domestic sources for GaN integrated circuit components to ensure the availability of critical components required for the Next Generation Jammer and other electronic warfare systems. Additionally, this initiative will mitigate program risk by ensuring on-shore availability of critical components, maintain secure sources for these essential electronic components through oversight of sources and processes, and address process and quality improvements to drive down costs.										
FY 2016 Project Descriptions										
III authorities to make investments in the dom U.S. for both current and future weapon syste	nestic industrial base that maintain the timely availability of cr ems, as informed by the Department's key investment strated	itical-need, technologically superior p gy documents including the Quadren	30 million. The purpose of this continuous effort is to use DPA Title production capabilities that are independently available within the nial Defense Review (QDR) and the Long Range Research and bling the production of capacity for technologies and materials							
LI TitleIII - Defense Production Act Pu	urchases UNCLA	SSIFIED	Volume 1 - 3							

Exhibit P-40, Budget Line Item Justification: PB 2017 Office of the Secretary Of I	Defense	Date: February 2016
Appropriation / Budget Activity / Budget Sub Activity:	P-1 Line Item Number / Title:	
0360D: Defense Production Act Purchases / BA 01: Defense Production Act	TitleIII / Defense Production Act P	Purchases
Purchases / BSA 10: Defense Production Act Purchases		
ID Code (A=Service Ready, B=Not Service Ready): Program Elements for Code B I	tems: 0902199D8Z Other	Related Program Elements: N/A
Line Item MDAP/MAIS Code: N/A Item MDAP/MAIS Code(s): N/A emerging from the technology base that the private sector is unable to respond to within DoD timelines.	Technology focus greas include space, unde	arsea air dominance strike missile defense and emerging
technologies.	rechnology locus areas include space, unde	
NSS ISB - Cadmium Zinc Telluride Substrates (Prior Years – FY 2016): The purpose of this potential proc cadmium zinc telluride (CZT) substrates for use in government satellite systems. Due to evolving Nation missile defense, and other space requirements need to maintain a strong industrial base for mercury cad the lattice-matching substrate CZT on which the detector array is grown. Existing domestically-produced infrared focal plane arrays. The focus of this effort will be on the expansion of CZT boule growth and larg substrates from 150mm diameter boules.	al Security Space (NSS) threat requirements Imium telluride (MCT) based infrared detecto I CZT substrates do not meet the size and qu	s, several agencies responsible for missile early warning, or technology. A key material for the MCT detector arrays is uality requirements necessary to produce large, space-quality
NSS ISB - Electron Beam Direct Write (FY 2016 new start): This project addresses a need for an advance mask costs, improved design turn-around times, improved yield & reliability, improved design security (tr foundries fabricating parts for space and defense applications at a relatively low cost (versus commercial first such insertion. The project is to complete the development of a piece of lithography equipment that the descriptions to a physical wafer being processed. Accomplishing this project brings a host of benefits where beam write (CEBW) methodology.	ust), and increased die sizes. Production ver I advanced lithography solutions in developm uses multiple electron beams (e-beams) to el	rsions of this tool would be inserted in U.S. integrated circuit nent) per system. The proposed project will accomplish the nable the direct transfer ("writing") of integrated circuit layer
NSS ISB - Next Generation Reaction Wheel Assemblies (RWA) (FY 2016 new start): This project address systematic comprehensive, low cost/risk investment affording potential for high return on investment. The a focus on smaller wheels using advanced technologies. In addition, investigate encouraging a business controlled by a U.S. company.	e goal is to generate or revive a domestic cor	mpetitor, or to expand the existing vendor's product line, with
NSS ISB - Next-Generation Star Trackers System (Prior Years – FY 2016): This project will establish the (NGSTS) that uses advanced domestically-produced Complementary Metal Oxide Semiconductor (CMC Project. This involves adherence to the Staring Technology for Enhanced Linear Line-of-site Angular Re US Government (including National Security Space) and commercial market demands for the foreseeable	S) detectors with a capability that meets the cognition (STELLAR) specification. A NGST	specifications of the DPA Title III Advanced CMOS Capability S with CMOS technology is needed to meet military and civil
NSS ISB - Photovoltaic Substrates Supply Chain Diversification (FY 2016 new start): The purpose of this for defense-critical, high-purity germanium (Ge) metal used for space-qualified photovoltaics in a wide ra night vision operations, airborne IR windows and optical systems, space-based IR optics, and high-efficie Government and commercial. The investment will ensure the long-term domestic supply of space-qualified allow the company to serve Ge wafer markets.	nge of warfighting and surveillance assets. T ency, multi-junction (M-J) photovoltaics (sola	Those assets include ground-based infrared (IR) optics for r cells) used on over 95% of all space satellite assets, both
NSS ISB - Radiation-Hardened Digital/Analog Production & Qualification (FY 2016 new start): It is imper early warning, missile defense, and other space requirements maintain a strong industrial base to supply DoD space qualified Application Specific Integrated Circuits (ASIC), Application Specific Standard Produ GPP) at the less than or equal to 45nm technology node to support onboard processing and other critical ASSP design flow, optimize selected circuit designs to reduce power and increase performance and com addition to achieving an estimated improvement in performance of > 25% for power and performance for for some identified systems with attendant reductions in system technical, cost and schedule risks.	r technology necessary to design, develop, a cts (ASSP), such as very high speed data sv I applications. The objective of this project is aplete the design, fabrication, test and qualifie	and fabricate Trusted, radiation hardened, high reliability and witches, and Multi-Core General Purpose Processors (MC- to enhance the Radiation Hardened By Design 45nm ASIC/ cation of certain critical devices to include the MC-GPP. In

Exhibit P-40, Budget Line Item Justification: PB 2017 Office of the Secretary Of I	Defense Date: February 2016
Appropriation / Budget Activity / Budget Sub Activity: 0360D: Defense Production Act Purchases / BA 01: Defense Production Act Purchases / BSA 10: Defense Production Act Purchases	P-1 Line Item Number / Title: TitleIII / Defense Production Act Purchases
ID Code (A=Service Ready, B=Not Service Ready): Program Elements for Code B I	tems: 0902199D8Z Other Related Program Elements: N/A
Line Item MDAP/MAIS Code: N/A Item MDAP/MAIS Code(s): N/A	
Optical devices, Glassless diodes, JANKC diode dies, and more. These components are used almost un	ilicon Field Effect Transistors (MOSFET), insulated-gate bipolar transistor (IGBT), Optocouplers and other inversally to provide power and conditioned signals to Application-Specific Integrated Circuit (ASIC) and pany is the only manufacturer of components that designs and produces entirely with US persons in a US ercial space, to companies such as Boeing, Lockheed Martin, and Space Systems Loral. The reduction e past 15 years has resulted in a substantial decrease of the industrial base, which is down to two main
NSS ISB - Trusted Field Programmable Gate Arrays (FPGAs) (FY 2016 new start): The DoD and Intellig present and future systems. Advanced, commercially available FPGAs do not meet the DoD requiremen and insertion of malicious software and/or hardware. This program seeks to improve the security posture development, fabrication and supply lifecycle of FPGA devices. The objective of this program is to develor reprogrammable FPGA technology to support DoD/IC applications including satellite and strategic missil product wherein that product will reliably operate as intentionally designed and not contain any malicious etc.	ts for Trusted systems as they are manufactured off-shore and are considered vulnerable to tampering and reduce the risk associated with FPGA technology by addressing security concerns in the design, op and demonstrate an approach to ensure the availability of advanced "Trusted" and space qualified
Projects Other (non NSS-ISB):	
	oviding advanced security features, while meeting all the operational, structural, and customs requirements rity of the container and report breaches to the cognizant authorities. The container includes the capability the container is to provide the level of security to law enforcement officials to ensure contraband products der Title III to establish initial production capability for the secure hybrid composite container can help
FY2015 Project Descriptions	
NSS ISB - Additive Manufacturing for Liquid Rocket Engines (Prior Years – FY 2015): Awarded in July 24 utilized by National Security Space (NSS) agencies to launch critical assets into Earth orbit. Advanced are in the powder bed compared to existing additive manufacturing equipment. This essential equipment pro rocket engines (LREs). The industrial base for precision manufactured components for LREs is high cost manufacturing technique, is estimated to provide a 30% to 80% reduction in critical component cost and establish and ex-situ qualify the production of various RL10 and RS-68 nickel, aluminum, and copper LR	dditive manufacturing equipment, now being deployed, provides up to a 600% volumetric increase vides the necessary build envelope and capabilities to produce larger critical components for liquid and is facing component obsolescence challenges. Direct Metal Laser Sintering (DMLS), an additive schedule for upper stage precision manufactured components. Under this effort the contractor will
NSS ISB - Complementary Metal Oxide Semiconductor (CMOS) Focal Plane Arrays (FPA) for Visible Se industrial base's ability to produce visible - imagers manufactured using Advanced Complementary Meta visible imaging systems on-board satellite and other systems for DoD and other US Government needs. Couple Device (CCD) sensor technology that has put domestic suppliers at a disadvantage with international statements and the systems are advantable of the systems and the systems and the systems are advantable of the systems and the systems and the systems are advantable of the systems are advantable of the systems and the systems are advantable of the systems are advanta	I Oxide Semiconductor (CMOS) technology. Advanced CMOS imagers are designed to enable flexible Current domestic Star Tracker manufacturers are using older, more expensive, and less capable Charged
NSS ISB - Read-Out Integrated Circuit (ROIC) Foundry Improvement and Sustainability (Prior Years – F assure the necessary supply of strategic ROICs deemed useful for Government space programs. This is	Y 2015): This project will maintain minimal yet adequate production capabilities at domestic foundries to nitiative is driven by low yields due to defect density, large die size and design complexity, and long periods

Exhibit P-40, Budget Line Item Justification: PB 2017 Office of the Secretary Office	Defense	Date: February 2016
Appropriation / Budget Activity / Budget Sub Activity: 0360D: Defense Production Act Purchases / BA 01: Defense Production Act Purchases / BSA 10: Defense Production Act Purchases	P-1 Line Item Number / Tit TitleIII / Defense Production	
ID Code (A=Service Ready, B=Not Service Ready): Program Elements for Code E	Items: 0902199D8Z	Other Related Program Elements: N/A
Line Item MDAP/MAIS Code: N/A Item MDAP/MAIS Code(s): N/A		
of time between orders due to the small market for large format ROICs. Essential systems include Bal on ROIC technology.	istic Missile Defense, Space Tracking	and Surveillance System and Exoatmospheric Kill Vehicles that rely
NSS ISB - Space Qualified Solar Cell Germanium Substrate Supply Chain (Prior Years – FY 2015): Th can procure defense-critical, NSS-qualified germanium substrates in quantity from a viable, operational yield, implementing internal refining and material recycling capability, expanding product family offering cells used on all NSS satellites and are forecast to continue as such for the next 10-15 years.	lly superior US domestic germanium su	ubstrate manufacturer. Objectives include increasing quality and
Projects Other (non NSS-ISB):		
Activated Carbon Capacity Expansion (Prior Years – FY 2015): The objective this project is to expand Chemical, Biological, Radiological, and Nuclear (CBRN) agents that could be used during acts of war or carbon is the only grade of carbon deemed acceptable by the DoD for collective and personal CBRN p with one production line to support 70+ DoD systems that utilize ASZM-TEDA activated carbon. The carbon project will expand domestic manufacturing capacity for activated carbon by partnering with a viable, we requirements and the needs of non-DoD user communities.	or terrorism. Copper-silver-zinc-molybo rotection systems and devices. Curren ompany is not currently incentivized to	denum-trietheylenediamine (ASZM-TEDA) impregnated activated tty, DoD relies on a single activated carbon manufacturing facility expand capacity to meet DoD surge requirements. This DPA Title III
Advanced Drop-In Biofuel Production (Prior Years – FY 2015): This is an effort to establish and scale- evaluated production technology, technical maturity, site selection, plant design, permitting, and details construct and commission a biofuel production plant capable of producing renewable, drop-in liquid tra with conventional petroleum and ready for immediate DoD operational use with no modification to distr	d cost estimation for four projects. In Insportation fuels leveraging existing int	Phase 2 each of the three firms whose proposals were accepted will
Modernization of Steel Plate Production (Prior Years – FY 2015): The purpose of this project is to enha steel plate used in US Navy ship construction. Modernization of plate production processes will improv efficiency. These improvements translate into less shipyard processing and rework time, and lower sh steel plate by partnering with a viable, world-class domestic manufacturer whose production processes	e quality and yield, increase throughpu p construction costs. This project will in	tt, reduce production cost, and result in improved ship construction mprove domestic manufacturing capability for Navy-grade alloy heavy
Scale Up of Green Energetics (Prior Years – FY 2015): This project will expand the domestic manufact that contain toxic compounds. The capabilities associated with existing primary energetic materials, when umerous ammunition, missile and aircraft applications. However, safer alternatives are needed due to health and safety concerns. Executive Order 12856 calls for the replacement of toxic materials used by energetic material is insufficient to meet DoD requirements, and several market barriers exist which in Title III of the Defense Production Act will spur industry to increase DBX-1 capacity, thereby enabling D	ich include lead azide (LA), lead styph the regulated toxins and heavy metals the Federal Government. Current don ibit private sector investments in capaci	nate (LS), and mercury (II) 5-nitrotetrazole (DXN-1), are essential for s contained in these materials that present dangerous environmental, nestic manufacturing capacity for alternative non-toxic primary city expansion. A public/private partnership under the authorities of
Thin Wall Castings for Military Applications (FY 2015): This DPA Title III project will maintain, moderni and aluminum sand casted rotorcraft parts by incentivizing the industrial base through a mix of governi magnesium and aluminum sand casted components to remain operationally viable and combat ready. sand casted components is in need of modernization but does not have adequate profitability or econor managed to recapitalize aging domestic foundries and to strengthen a diminishing supply base in order	nent and contractor-shared investment The US domestic supply base for the p mic incentive to undertake the necessa	ts. All US Military rotorcraft vehicles require complex, large, multi-core production of complex, large, multi-core magnesium and aluminum ary investments on its own. These investments will be designed and

EXHIBIT P-5, COST	Analysis	S: PB 20	017 Office	of the Sec	retary Of Def	ense					Date	: Februar	y 2016		
Appropriation / B 0360D / 01 / 10	udget A	ctivity /	Budget \$	Sub Activit	-		Number / T e Productio		ases			Number efense Pr			
ID Code (A=Service Read	ly, B=Not Serv	ice Ready):			·			MDAP/MA	IS Code:		·				
Resource S	umman	,	Prior Years ⁽⁺⁾	FY 2015	FY 2016	FY 2017 Base	FY 2017 OCO	FY 2017 Total	FY 2018	FY 2019	FY 202	20 FY 2	021	To mplete	Total
Procurement Quantity (Uni	•		Itais	112013	FT 2010	Dase		TOLAT		F1 2013	11204	.0 112	-	Inhiere	TULAI
Gross/Weapon System Co		191	1,598.637	96.63		44.065	-	44.065	37.109	38.65	7 35	939		- ntinuing	Continuing
Less PY Advance Procure			1,000.007		-							-	-	-	continuing
Net Procurement (P-1) (\$ i	•		1,598.637	96.63		44.065		44.065	37.109	38.65	7 35	939	30.348 Coi	ntinuing	Continuing
Plus CY Advance Procure	,	lions)	-	-	-	-		-	-	-		-	-	-	
Total Obligation Authorit	•	,	1,598.637	96.63	3 76.680	44.065	-	44.065	37.109	38.65	7 35.	939	30.348 Co	ntinuing	Continuing
<u> </u>		,	,		for informational p		ne corresponding								J
Initial Spares (\$ in Millions)	(1.1.5		-	-	-	-	-		-	-		-	-	-	-
Gross/Weapon System Ur	nit Cost (\$ in I	Millions)	-	-	_	-		-	-	-		-	-	-	-
	,	.646 milli													
Note: Subtotals or Totals i	n this Exhibit	P-5 may n	ot be exact or				Y 2016	F	Y 2017 Base		FY 201	7 0C0		FY 2017	Total
Note: Subtotals or Totals i	n this Exhibit	P-5 may n Prior Year Qty	ot be exact or 's Total Cost	FY Unit Cost	2015 Total Qty Cost	Unit Cost	Tot Qty Co	al st Unit Cost			FY 201	Tota y Cost	Unit Co		Total Cost
Note: Subtotals or Totals i Cost Elements	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or S Total Cost (\$ M)	Unit Cost (\$ M) (1	2015 Total Qty Cost Each) (\$ M)		Tot	al st Unit Cost		Cost Unit		Tota y Cost			Total Cost
Note: Subtotals or Totals i Cost Elements Hardware - National Security	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or S Total Cost (\$ M)	Unit Cost (\$ M) (1	2015 Total Qty Cost Each) (\$ M)	Unit Cost	Tot Qty Co	al st Unit Cost	Qty	Cost Unit	Cost Qt	Tota y Cost	Unit Co	ost Qty	/ Total / Cost
Note: Subtotals or Totals i Cost Elements	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or S Total Cost (\$ M)	Unit Cost (\$ M) (1	2015 Total Qty Cost Each) (\$ M)	Unit Cost (\$ M)	Tot Qty Co	al st Unit Cost	Qty	Cost Unit	Cost Qt	Tota y Cost	Unit Co	ost Qty	/ Total / Cost
Note: Subtotals or Totals i Cost Elements Hardware - National Security Non Recurring Cost NSS ISB: Comp Metal Oxide Semiconductor Focal Plane Arrays for Visible Sensors for	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or 's Total Cost (\$ M) upply Base (ISB	Unit Cost (\$ M) (1	2015 Total Cost (\$ M) rogram Cost	Unit Cost (\$ M) -	Tot Qty Co	al st Unit Cost	Qty	Cost Unit	Cost Qt	Tota y Cost	Unit Co	ost Qty	/ Total / Cost
Note: Subtotals or Totals i Cost Elements Hardware - National Security Non Recurring Cost NSS ISB: Comp Metal Oxide Semiconductor Focal Plane Arrays for Visible Sensors for Star Trackers NSS ISB: Read Out Integrated Circuit (ROIC) Foundry Improvement and	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or 'S Total Cost (\$ M) upply Base (ISB 9.416	FY Unit Cost (\$ M)) Risk Mitigation P -	2015 Total Cost (\$ M) rogram Cost - 1.69	Unit Cost (\$ M) -	Qty (Each) (\$ M	al st Unit Cost	Qty	Cost Unit	Cost Qt	Tota y Cost		ost Qty	/ Total / Cost
Note: Subtotals or Totals i Cost Elements Hardware - National Security Non Recurring Cost NSS ISB: Comp Metal Oxide Semiconductor Focal Plane Arrays for Visible Sensors for Star Trackers NSS ISB: Read Out Integrated Circuit (ROIC) Foundry Improvement and Sustainability NSS ISB: Cadmium Zinc Telluride	n this Exhibit F Unit Cost	P-5 may n Prior Year Qty (Each)	ot be exact or 'S Total Cost (\$ M) upply Base (ISB 9.416 7.832	FY Unit Cost (\$ M) (I) Risk Mitigation P	2015 Total Cost (\$ M) rogram Cost - 1.69 - 2.37	Unit Cost (\$ M) - - - - - -	Qty (Each) (\$ M	al Unit Cost () (\$ M) 	Qty	Cost Unit	Cost Qt	-		-	/ Total / Cost

Exhibit P-5, Cost	Analysis	s: PB 20	17 Office	e of the S	Secretary	Of Defe	ense				Date: February 2016									
Appropriation / E 0360D / 01 / 10	Budget A	ctivity /	Budget	Sub Act	ivity:		Line Iten III / Defer				Item Number / Title [DODIC]: 1 / Defense Production Act Purchases									
D Code (A=Service Rea	dy, B=Not Servi	ce Ready):							М											
Note: Subtotals or Totals	in this Exhibit	P-5 may no	ot be exact o	or sum exactl	y due to rou	nding.														
	F	Prior Years	S		FY 2015			FY 2016	-	FY	2017 Ba	se	F۱	FY 2017 OCO FY 2017 Total						
Cost Elements	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)		
NSS ISB: Electron Beam Direct Write	-	-	-	-	-	-	-	-	11.500	. ,	-	-	-	-	-	-	-	-		
NSS ISB: Trusted Field Programmable Gate Arrays	-	-	-	-	-	-	-	-	1.500	-	-	-	-	-	-	-	-	-		
NSS ISB: Radiation- Hardened Digital/ Analog Production & Qualification	-	-	-	-	-	-	-	-	2.700	-	-	-	-	-	-	-	-	-		
NSS ISB: Radiation- Hardened Transistors & Diodes	-	-	-	-	-	-	-	-	2.000	-	-	-	-	-	-	-	-	-		
NSS ISB: Next Generation Reaction Wheels Assembly	-	-	-	-	-	-	-	-	0.500	-	-	-	-	-	-	-	-	-		
NSS ISB: Photovoltaic Substrates Supply Chain Diversification	-	-	-	-	-	-	-	-	0.800	-	-	-	-	-	-	-	-	-		
NSS ISB: Space Industrial Base Capability	-	-	-	-	-	-	-	-	-	-	-	21.000	-	-	-	-	-	21.00		
NSS ISB: Next Generation Star Trackers	-	-	6.228	-	-	6.139	-	-	10.402	-	-	-	-	-	-	-	-			
Subtotal: Non Recurring Cost	-	-	41.856	-	-	14.500	-	-	33.502	-	-	21.000	-	-	-	-	-	21.0		
Subtotal: Hardware - National Security Space (NSS) Industrial & Supply Base (ISB) Risk Mitigation Program Cost	-	-	41.856	-	-	14.500	-	-	33.502	-	-	21.000	-	-	-	-	-	21.0		
Hardware - Other Cost																				
Non Recurring Cost	· · · · ·					[1			,						1 1				
Activated Carbon Capacity Expansion	-	-	29.135	-	-	13.865	-	-	-	-	-	-	-	-	-	-	-	-		
Modernization of Steel Plate Production	-	-	18.000	-	-	3.000	-	-	-	-	-	-	-	-	-	-	-	-		
Scale Up of Green Energetics	-	-	2.000	-	-	2.000	-	-	-	-	-	-	-	-	-	-	-	-		
Advanced Drop-In Biofuel Production	-	-	205.000	-	-	45.000	-	-	-	-	-	-	-	-	-	-	-	-		
Thin Wall Castings for Military Applications	-	-	-	-	-	18.273	-	-	-	-	-	-	-	-	-	-	-	-		

Exhibit P-5, Cost															Date: February 2016					
Appropriation / B 0360D / 01 / 10	udget A	ctivity /	Budget	Sub Act	ivity:					ct Purcha	ases			Item Number / Title [DODIC]: 1 / Defense Production Act Purchases						
ID Code (A=Service Read	ly, B=Not Serv	rice Ready):							M	DAP/MAIS	Code:									
Note: Subtotals or Totals i	n this Exhibi	t P-5 may no	ot be exact o	r sum exactl	y due to rou	inding.														
	I	Prior Years	5		FY 2015			FY 2016		FY	′ 2017 Ba	se	F	Y 2017 OC	0	F	Y 2017 Tot	al		
Cost Elements	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)		
Secure Composite Shipping Containers	-	-	-	-	-	-	-	-	7.267	-	-	2.000	-	-	-	-	-	2.000		
Advanced Weapon Component/Materials Production	-	-	-	-	-	-	-	-	35.911	-	-	11.865	-	-	-	-	-	11.865		
Advanced Microelectronics Trusted Foundry	-	-	-	-	-	-	-	-	-	-	-	7.200	-	-	-	-	-	7.200		
Next Generation Jammer Gallium Nitride (GaN) MMIC & Wideband Circulator Technologies	-	-	16.000	-	-	-	-	-	-	-	-	2.000	-	-	-	-	-	2.000		
Subtotal: Non Recurring Cost	-	-	270.135	-	-	82.138	-	-	43.178	-	-	23.065	-	-	-	-	-	23.065		
Subtotal: Hardware - Other Cost	-	-	270.135	-	-	82.138	-	-	43.178	-	-	23.065	-	-	-	-	-	23.065		
Gross/Weapon System Cost	-	-	1,598.637	-	-	96.638	-	-	76.680	-	-	44.065	-	-	-	-	-	44.065		
		FY 2018			FY 2019			FY 2020		FY 2021			To Complete			Total Cost		t		
Cost Elements	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)		
Hardware - National Security	Space (NSS) I	Industrial & Su	pply Base (ISI	B) Risk Mitigati	on Program C	Cost														
Non Recurring Cost		1											1			1				
NSS ISB: Comp Metal Oxide Semiconductor Focal Plane Arrays for Visible Sensors for Star Trackers	-	-	-	-		-	-	-	-	-	-	-	-	-	-	-	-	11.106		
NSS ISB: Read Out Integrated Circuit (ROIC) Foundry Improvement and Sustainability	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	10.203		
NSS ISB: Cadmium Zinc Telluride Substrates	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	12.400		
NSS ISB: Space Qualified Solar Cell Germanium Substrate Supply Chain	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	7.680		

Exhibit P-5, Cost	Analysi	s: PB 20	17 Office	e of the S	Secretary	Of Defe	ense							Date: Fe	ebruary 2	2016		
Appropriation / B 0360D / 01 / 10	udget A	ctivity /	Budget	Sub Act	ivity:		ine Iten II / Defer				Item Number / Title [DODIC]: 1 / Defense Production Act Purchases							
D Code (A=Service Read	ly, B=Not Serv	rice Ready):							М	DAP/MAI	S Code:		1					
		FY 2018			FY 2019			FY 2020			FY 2021		Т	To Complete Total Cost				
Cost Elements	Unit Cost	Qty (Each)	Total Cost (\$ M)	Unit Cost	Qty (Each)	Total Cost (\$ M)	Unit Cost	Qty (Each)	Total Cost (\$ M)	Unit Cost	Qty (Each)	Total Cost (\$ M)	Unit Cost	Qty (Each)	Total Cost (\$ M)	Unit Cost	Qty (Each)	Total Cost (\$ M)
NSS ISB: Additive Manufacturing for Liquid Rocket Engines	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	6.70
NSS ISB: Electron Beam Direct Write	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	11.50
NSS ISB: Trusted Field Programmable Gate Arrays	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	1.50
NSS ISB: Radiation- Hardened Digital/ Analog Production & Qualification	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	2.70
NSS ISB: Radiation- Hardened Transistors & Diodes	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	2.00
NSS ISB: Next Generation Reaction Wheels Assembly	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	0.50
NSS ISB: Photovoltaic Substrates Supply Chain Diversification	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	0.80
NSS ISB: Space Industrial Base Capability	-	-	21.000	-	-	21.000	-	-	21.000	-	-	15.000		Continuing			Continuing	
NSS ISB: Next Generation Star Trackers	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	22.76
Subtotal: Non Recurring Cost	-	-	21.000	-	-	21.000	-	-	21.000	-	-	15.000		Continuing			Continuing	
Subtotal: Hardware - National Security Space (NSS) Industrial & Supply Base (ISB) Risk Mitigation Program Cost	-	-	21.000	-	-	21.000	-	-	21.000	-	-	15.000		Continuing			Continuing	
Hardware - Other Cost																		
Non Recurring Cost	[1						[1					,	
Activated Carbon Capacity Expansion	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	43.00
Modernization of Steel Plate Production	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	21.00
Scale Up of Green Energetics	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	4.00
Advanced Drop-In Biofuel Production	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	250.00

Exhibit P-5, Cost	Analysis	: PB 20	17 Office	e of the S	Secretary	Of Defe	ense							Date: Fe	ebruary 2	2016					
Appropriation / B 0360D / 01 / 10	udget Ad	ctivity /	Budget	Sub Act	ivity:	1	P-1 Line Item Number / Title: TitleIII / Defense Production Act Purchases									Item Number / Title [DODIC]: 1 / Defense Production Act Purchases					
ID Code (A=Service Read	ly, B=Not Servi	ce Ready):				•			M	DAP/MAIS	S Code:										
		FY 2018			FY 2019			FY 2020			FY 2021		Т	o Complet	te		Total Cost	t			
Cost Elements	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)	Unit Cost (\$ M)	Qty (Each)	Total Cost (\$ M)			
Thin Wall Castings for Military Applications	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	18.273			
Secure Composite Shipping Containers	-	-	3.000	-	-	6.824	-	-	-	-	-	-	-	-	-	-	-	19.09 [.]			
Advanced Weapon Component/Materials Production	-	-	10.109	-	-	7.833	-	-	14.939	-	-	15.348		Continuing			Continuing				
Advanced Microelectronics Trusted Foundry	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	7.200			
Next Generation Jammer Gallium Nitride (GaN) MMIC & Wideband Circulator Technologies	-	-	3.000	-	-	3.000	-	-	-	-	-	-	-	-	-	-	-	24.000			
Subtotal: Non Recurring Cost	-	-	16.109	-	-	17.657	-	-	14.939	-	-	15.348		Continuing			Continuing				
Subtotal: Hardware - Other Cost	-	-	16.109	-	-	17.657	-	-	14.939	-	-	15.348		Continuing			Continuing				
Gross/Weapon System Cost	-	-	37.109	-	-	38.657	-	-	35.939	-	-	30.348		Continuing			Continuing				

THIS PAGE INTENTIONALLY LEFT BLANK